

Hi all,

Here is the minute of the meeting today.

o Cooling Plate of ROC board <Rachid>

- **Rachid** will ship cooling plates to Japan and Taiwan together with copper tubes and thermal pads.

o Assembly <Rachid>

- **Rachid** will update the assembly tables with the final measurements.

o Taiwan Assembly <Cheng-Wei>

- **Cheng-Wei** will check number of silicons available in Taiwan. 17 silicons

- Cheng-Wei's noise measurement demonstrated 0.2hits/min./channel with DAC0=40 threshold setting.

- **Itaru** will initiate discussion with Ming and Rachid if we can ship some silicons in Taiwan to BNL to let BNL finish assembly. We'll purchase silicons from next years budget and provide them to Taiwan after April, 2022.

o Production Status <Itaru>

- **Itaru** will add ARS's cost estimate for each components by ARS co. and then let the table to be shared with other collaborators so that they can check the price of each components in their country. If they are drastically cheaper, we can purchase these components and provide to the company.

- **Itaru** will negotiate to produce 30 bus extenders instead of 20 for the next prototype round. This way, we can assemble a half barrel of 1A and 1B layers (requires 28).

Best regards,

-itaru

On 2021/10/08 11:14, Itaru Nakagawa wrote:

Dear all,

We'll have weekly INTT meeting on

**Oct 8th Friday 9AM in BNL = Oct. 8th Friday 10PM in Japan = Friday 9PM in Taiwan**

\*indico

<https://indico.bnl.gov/event/13510/>

\*Zoom

<https://zoom.us/j/92149923535>

Best regards,

-itaru

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